



INTERFLUX[®] PACIFIC 2008

"No-Residue" flux

DESCRIPTION

The Interflux[®] PACIFIC 2008 is an environment friendly flux specially developed without any presence of volatile organic compounds. The flux contains no halides, neither rosin nor resin components.

It can be used till the last drop, it will give excellent soldering results and no contact problems.

The wetting capacity is optimal. PACIFIC 2008 is recommended for soldering with lead-free alloys and for components and PCB-finishes with critical solderability.

PHYSICAL AND CHEMICAL PROPERTIES

# Density at 20°C	: 1.006 g/ml ± 0.0025
# Colour	: colourless
# Odour	: sweet smell
# Solids content % w/w	: 3.7 % ± 0.15
# Halide content	: 0 %
# Flash point (T.O.C.)	: none
# Total Acid Number	: 24 mg KOH/g ± 1

APPLICATIONS

This flux is suitable for use with spray techniques.

All water should be evaporated before the PCB reaches the solder wave.

Contact time of PCB with the solder should be between 2 and 5 seconds.

PACKAGING

10 litres and 25 litres in high density polyethylene drums.

APPROVALS AND TEST RESULTS

IPC test results included.

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